DATASHEET

Description

The 5P49EE802 is a programmable clock generator intended for low power, battery operated consumer applications. There are four internal PLLs, each individually programmable, allowing for up to eight different output frequencies. The frequencies are generated from a single reference clock. The reference clock can come from either a TCXO or fundamental mode crystal. An additional 32kHz crystal oscillator is available to provide a real time clock or non-critical performance MHz processor clock.

The 5P49EE802 can be programmed through the use of the I²C interfaces. The programming interface enables the device to be programmed when it is in normal operation or what is commonly known as in system programmable. An internal EEPROM allows the user to save and restore the configuration of the device without having to reprogram it on power-up.

Each of the four PLLs has an 8-bit reference divider and a 11-bit feedback divider. This allows the user to generate four unique non-integer-related frequencies. The PLL loop bandwidth is programmable to allow the user to tailor the PLL response to the application. For instance, the user can tune the PLL parameters to minimize jitter generation or to maximize jitter attenuation. Spread spectrum generation is supported on one of the PLLs.

Spread spectrum generation is supported on one of the PLLs. The device is specifically designed to work with display applications to ensure that the spread profile remains consistent for each HSYNC in order to reduce ROW noise. It also may operate in standard spread spectrum mode.

There are total seven 8-bit output dividers. Outputs are LVCMOS. The outputs are connected to the PLLs via the switch matrix. The switch matrix allows the user to route the PLL outputs to any output bank. This feature can be used to simplify and optimize the board layout. In addition, each output's slew rate and enable/disable function can be programmed.

Target Applications

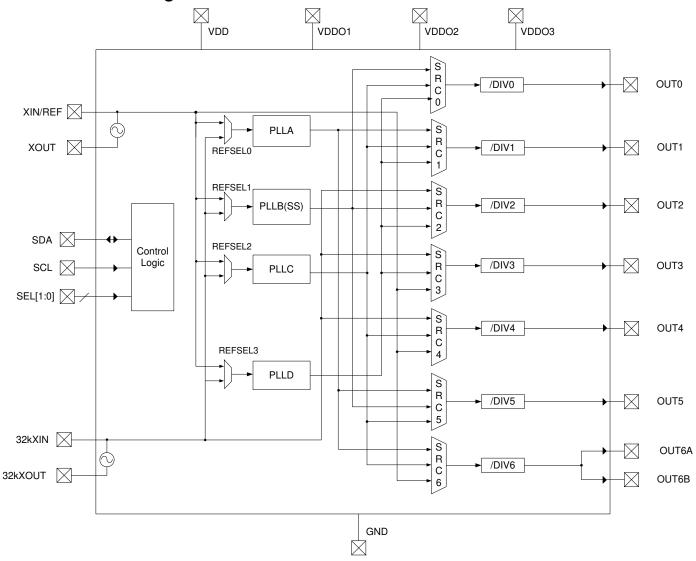
- · Smart Mobile Handset
- Personal Navigation Device (PND)
- Camcorder
- DSC
- · Portable Game Console
- Personal Media Player

Features

- · Four internal PLLs
- Internal non-volatile EEPROM
- Internal I²C EEPROM master interface
- FAST (400kHz) mode I²C serial interfaces
- Input Frequencies
 - TCXO: 10 MHz to 40 MHz - Crystal: 8 MHz to 30 MHz - RTC Crystal: 32.768 kHz
- Output Frequency Ranges: kHz to 120 MHz
- Each PLL has an 8-bit reference divider and a 11-bit feedback-divider
- 8-bit output-divider blocks
- One of the PLLs support Spread Spectrum generation capable of configuration to pixel rate, with adjustable modulation rate and amplitude to support video clock with no visible artifacts
- I/O Standards:
 - Outputs 1.8V/2.5V/3.3 V LVTTL/ LVCMOS
 - 3 independent adjustable VDDO groups
- Programmable Slew Rate Control
- · Programmable Loop Bandwidth Settings
- · Programmable output inversion to reduce bimodal jitter
- Individual output enable/disable
- Power-down/Sleep mode
 - 10μA max in power down mode
 - 32kHz clock output active sleep mode
 - 100µA max in sleep mode
- 1.8V VDD Core Voltage
- Available in 28 pin 4x4mm QFN packages
- -40 to +85°C Industrial Temp operation

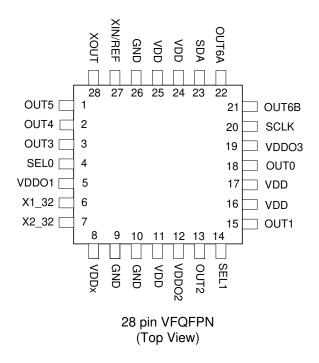


Functional Block Diagram





Pin Assignment



Pin Descriptions

Pin Name	Pin #	I/O	Pin Type	Pin Description
OUT5	1	0	Adjustable	Configurable clock output 5. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.
OUT4	2	0	Adjustable	Configurable clock output 4. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.
OUT3	3	0	Adjustable	Configurable clock output 3. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.
SEL0*	4	I	LVTTL	Configuration select pin. Weak internal pull down resistor.
VDDO1	5		Power	Device power supply. Connect to 1.8 to 3.3V. Using register settings, select output voltage levels for OUT0-OUT6. VDDO1 must be greater than or equal to both VDDO2 and VDDO3.
X132k	6	I	LVTTL	32kHz CRYSTAL_IN Reference crystal input
X232k	7	I	LVTTL	32kHz CRYSTAL_OUT Reference crystal feedback.
VDDx	8		Power	Crystal oscillator power supply. Connect to 1.8V. Use filtered analog power supply if available.
GND	9		Power	Connect to Ground.
GND	10		Power	Connect to Ground.
VDD	11		Power	Device power supply. Connect to 1.8V.
VDDO2	12		Power	Device power supply. Connect to 1.8 to 3.3V. Using register settings, select output voltage levels for OUT0-OUT5.
OUT2	13	0	Adjustable	Configurable clock output 2. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.
SEL1*	14	I	LVTTL	Configuration select pin. Weak internal pull down resistor.
OUT1	15	0	Adjustable	Configurable clock output 1. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.

Pin Name	Pin#	I/O	Pin Type	Pin Description		
VDD	16		Power	Device power supply. Connect to 1.8V.		
VDD	17		Power	Device power supply. Connect to 1.8V.		
OUT0	18	0	Adjustable	Configurable clock output 0. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.		
VDDO3	19		Power	Device power supply. Connect to 1.8 to 3.3V. Using register settings, select output voltage levels for OUT0-OUT5.		
SCLK	20	I	LVTTL	I ² C clock. Logic levels set by VDDO1. 5V tolerant.		
OUT6B	21	0	Adjustable	Configurable clock output 6B. Output voltage levels are controlled by VDDO1.		
OUT6A	22	0	Adjustable	Configurable clock output 6A. Output voltage levels are controlled by VDDO1.		
SDA	23	I/O	LVTTL	Bidirectional I ² C data. Logic levels set by VDDO1. 5V tolerant.		
VDD	24		Power	Device power supply. Connect to 1.8V.		
VDD	25		Power	Device power supply. Connect to 1.8V.		
GND	26		Power	Connect to Ground.		
XIN/ REF	27	I	LVTTL	MHz CRYSTAL_IN Reference crystal input or external reference clock input. Maximum clock input voltage is 1.8V.		
XOUT	28	0	LVTTL	MHz CRYSTAL_OUT Reference crystal feedback. Float pin if using reference input clock.		

Note *: SEL pins should be controlled by 1.8V LVTTL logic; 3.3V tolerant.

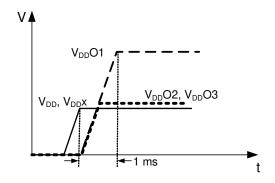
Note 1: Outputs are user programmable to drive single-ended 1.8V/2.5V/3.3V LVTTL as indicated above. Always completely power up VDD and VDDx prior to applying VDDO power.

Note 2: Default factory configuration OUT4=buffered reference output & OUT2=32.768KHz. All other outputs are off.

Note 3: Do not power up with SEL[1:0] = 00 (in Power down/Sleep mode).

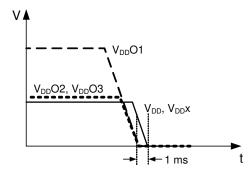
Ideal Power Up Sequence

- 1) V_{DD} and $V_{DD}x$ must come up first, followed by $V_{DD}O$
- 2) V_{DD}O1 must come up within 1ms after VDD and VDDX come up
- 3) $V_{DD}O2/3$ must be equal to, or lower than, $V_{DD}O1$
- 4) V_{DD} and V_{DD}x have approx. the same ramp rate
- 5) V_{DD}O1 and V_{DD}O2/3 have approx. same ramp rate



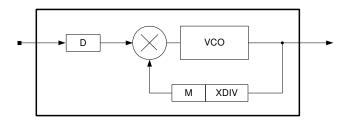
Ideal Power Down Sequence

- 1) $V_{DD}O$ must drop first, followed by V_{DD} and $V_{DD}x$
- 2) V_{DD} and $V_{DD}x$ must come down within 1ms after $V_{DD}O1$ comes down
- 3) V_{DD}O2/3 must be equal to, or lower than, V_{DD}O1
- 4) V_{DD} and $V_{\text{DD}}x$ have approx. the same ramp rate
- 5) $V_{DD}O1$ and $V_{DD}O2/3$ have approx. same ramp rate





PLL Features and Descriptions



PLL Block Diagram

	Ref-Divider (D) Values	Feedback Pre-Divider (XDIV) Values	Feedback (M) Values	Programmable Loop Bandwidth	Spread Spectrum Generation Capability
PLLA	1 - 255	1 or 4	6 - 2047	Yes	No
PLLB	1 - 255	4	6 - 2047	Yes	Yes
PLLC	1 - 255	1 or 8 bit divide	6 - 2047	Yes	No
PLLD	1 - 255	1 or 4	6 - 2047	Yes	No

Crystal Input (XIN/REF)

The crystal oscillators should be fundamental mode quartz crystals; overtone crystals are not suitable. Crystal frequency should be specified for parallel resonance with 50Ω maximum equivalent series resonance. 0

ONXTALB=0 bit needs to be set for XIN/REF.

Crystal Load Capacitors

The device crystal connections should include pads for small capacitors from X1 to ground and from X2 to ground. These capacitors are used to adjust the stray capacitance of the board to match the nominally required crystal load capacitance. Because load capacitance can only be increased in this trimming process, it is important to keep stray capacitance to a minimum by using very short PCB traces (and no vias) between the crystal and device. Crystal capacitors must be connected from each of the pins X1 and X2 to ground.

The crystal capacitors are internal to the device and have an effective value of 4pF.

Reference Pre-Divider, Reference Divider, Feedback-Divider and Post-Divider

Each PLL incorporates an 8-bit reference-scaler and a 11-bit feedback divider which allows the user to generate four unique non-integer-related frequencies. PLLA and PLLD each have a feedback pre-divider that provides additional multiplication for kHz reference clock applications. Each output divider supports 8-bit post-divider. The following equation governs how the output frequency is calculated.

$$F_{OUT} = \frac{F_{IN} * \left(\frac{XDIV*M}{D}\right)}{ODIV} (Eq. 2)$$

Where F_{IN} is the reference frequency, XDIV is the feedback pre-divider value, M is the feedback-divider value, D is the reference divider value, ODIV is the total post-divider value, and F_{OUT} is the resulting output frequency. Programming any of the dividers may cause glitches on the outputs.



Spread Spectrum Generation (PLLB)

PLLB has spread spectrum generation capability, which users have the option of turning on and off. Spread spectrum profile, frequency, and spread are fully programmable (within limits). The programmable spread spectrum generation parameters are NC[10:0], MOD[12:0], and NSS[10:0] bits. To enable spread spectrum, set SSENB B=0.

The spread spectrum circuitry was specifically developed to accommodate video display applications. The spread modulation frequency can be defined to exactly equal the horizontal line frequency (HSYNC)

NC[10:0]

These bits are used to determine the number of pulses per spread spectrum cycle. For video applications, NC is the number of pixels on the horizontal display row (or integer multiple of displayed pixels in a row). By matching the spread period to the screen, no tearing or "shimmer" will be apparent.

NC must be an even number to insure that the upward spread transition has the same number of steps as the downward spread transition.

For non-video applications, this can also be seen as the number of clock cycles for a complete spread spectrum period.

MOD[12:0]

These bits relate the VCO frequency to the target average spread output frequency (F_{MID}).

$$F_{MID} = (F_{VCO}) / 8$$

$$F_{MAX} = F_{MID} + (SS\% * F_{MID})$$

$$F_{MIN} = F_{MID} - (SS\% * F_{MID})$$

$$MOD = (F_{REF}^* NC) / (2 * F_{MID})$$

NSS[10:0]

These bits control the amplitude of the spread modulation.

$$NSS = (NC/2) + (NC/8) * (F_{MAX} - F_{MIN}) / F_{MID}$$

Modulation frequency:

$$F_{MOD} = F_{MID} / NC$$
 (Eq. 11)

Video Example

 F_{REF} = 27 MHz, F_{OUT} = 27 MHz, 640 pixels per line, center spread of ±1%. Using F_{VCO} =432MHz, find the necessary spread spectrum register settings.

$$F_{MID} = F_{VCO}/8$$

NC = 640 (integer number of spread periods/screen)

$$MOD = (25MHz * 640)/(2 * 54MHz) = 160$$

$$NSS = (640/2) + (640/8) * (27.27MHz - 26.73MHz) / 27MHz = 321.$$

$$F_{MOD} = 27MHz/640 = 11.8kHz.$$

Non-Video Example

 F_{REF} = 25MHz, F_{OUT} = 27 MHz, 31.25kHz modulation rate, center spread of ±1%. Find the necessary spread spectrum register settings.

$$F_{MID} = F_{VCO}/8$$

$$F_{MOD} = 31.25 \text{kHz} = 50.625 \text{MHz/NC}.$$

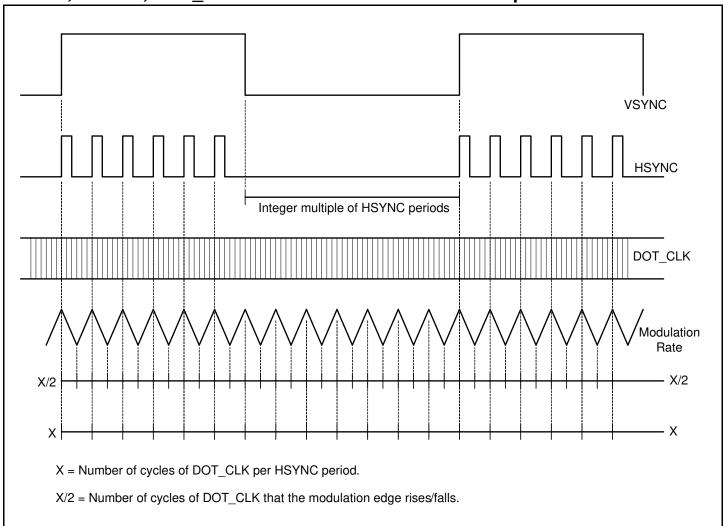
$$NC = 1620$$

$$MOD = (25MHz * 1620)/(2 * 50.625MHz) = 400$$

NSS =
$$(1620/2)+(1620/8)*(27.27MHz-26.73MHz)/27MHz = 814$$
.

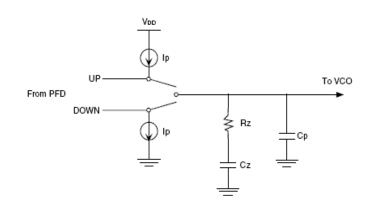


VSYNC, HSYNC, DOT_CLK - Modulation Rate Relationship



Loop Filter

The loop filter for each PLL can be programmed to optimize the jitter performance. The low-pass frequency response of the PLL is the mechanism that dictates the jitter transfer characteristics. The loop bandwidth can be extracted from the jitter transfer. A narrow loop bandwidth is good for jitter attenuation while a wide loop bandwidth is best for low jitter generation. The specific loop filter components that can be programmed are the resistor via the RZ[4:0] bits, zero capacitor via the CZ[2:0] bits, pole capacitor via the CP[1:0] bits, and the charge pump current via the IP#[2:0] bits.



The following equations govern how the loop filter is set:

Zero capacitor (Cz) = 280pF

Pole capacitor (Cp) = 30pF

Charge pump (Ip) = IP#[2:0] uA

VCO gain (Kvco) = $350MHz/V * 2\pi$



PLL Loop Bandwidth:

Charge pump gain $(K\phi)$ = Ip / 2π

VCO gain (Kvco) = $350MHz/V * 2\pi$

M = Total multiplier value (See the PRE-SCALERS, FEEDBACK-DIVIDERS, POST-DIVIDERS section for more detail)

$$\omega c = (Rz * K\phi * Kvco * Cz)/(M * (Cz + Cp))$$

 $Fc = \omega c / 2\pi$

Note, the phase/frequency detector frequency (FPFD) is typically seven times the PLL closed-loop bandwidth (Fc) but too high of a ratio will reduce your phase margin thus compromising loop stability.

To determine if the loop is stable, the phase margin (ϕm) would need to be calculated as follows.

Phase Margin:

$$\omega z = 1 / (Rz * Cz)$$

$$\omega p = (Cz + Cp)/(Rz * Cz * Cp)$$

$$\phi m = (360 / 2\pi) * [tan^{-1}(\omega c / \omega z) - tan^{-1}(\omega c / \omega p)]$$

To ensure stability in the loop, the phase margin is recommended to be > 60° but too high will result in the lock time being excessively long. Certain loop filter parameters would need to be compromised to not only meet a required loop bandwidth but to also maintain loop stability.

Damping Factor:

$$\zeta = Rz/2 * (Kvco * Ip * Cz)^{1/2}/M$$

Example

Fc = 150KHz is the desired loop bandwidth. The total A*M value is 160. The ζ (damping factor) target should be 0.7, meaning the loop is critically damped. Given Fc and A*M, an optimal loop filter setting needs to be solved for that will meet both the PLL loop bandwidth and maintain loop stability.

Choose a mid-range charge pump from register table

$$K_{\phi}$$
 * $K_{VCO} = 350MHz/V$ * $40uA = 12000A/Vs$

$$\omega c = 2\pi * Fc = 9.42x10^{5} s^{-1}$$

$$\omega p = (Cz + Cp)/(Rz * Cz * Cp) = \omega z (1 + Cz / Cp)$$

Solving for Rz, the best possible value Rz=30kOhms (RZ[1:0]=10) gives

 ζ = 1.4 (Ideal range for ζ is 0.7 to 1.4)

Solving back for the PLL loop bandwidth, Fc=149kHz.

The phase margin must be checked for loop stability.

$$\phi m = (360 / 2\pi) * [tan_{-1} (9.42x10^5 s^{-1} / 1.19x10^5 s^{-1}) - tan_{-1}^{-1} (9.42x10^5 s^{-1} / 1.23x10^6 s^{-1})] = 45^{\circ}$$

The phase margin would be acceptable with a fairly stable loop.



SEL[1:0] Function

The 5P49EE802 can support up to three unique configurations. Users may pre-program all configurations, selected using SEL[1:0] pins. Alternatively, users may use I2C interface to configure these registers on- the-fly.

Power Down/Sleep Mode is selected by the No_PD bit. No_PD=0 enables Power Down mode with no outputs. No_PD=1 enables sleep mode with 32kHz output on OUT2.

Always power with SEL1=1 and/or SEL0=1.

SEL1	SEL0	Configuration Selections
0	0	Power Down/Sleep Mode
0	1	Select CONFIG0
1	0	Select CONFIG1
1	1	Select CONFIG2

Configuration OUTx IO Standard

Users can configure the individual output IO standard from a single 3.3V power supply. Each output can support 1.8V/2.5V or 3.3V LVCMOS. VDDO1 must have the highest voltage of

any pin on the device. VDDO2 and VDDO3 may have any value between 1.8V and VDDO1.

Programming the Device

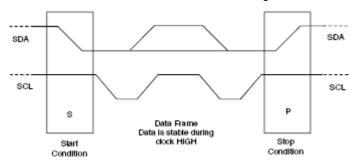
I²C may be used to program the 5P49EE802.

- Device (slave) address = 7'b1101010

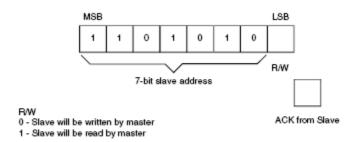
I²C Programming

The 5P49EE802 is programmed through an I^2 C-Bus serial interface, and is an I^2 C slave device. The read and write transfer formats are supported. The first byte of data after a write frame to the correct slave address is interpreted as the register address; this address auto-increments after each byte written or read.

The frame formats are shown in the following illustration.



Framing



The first byte transmitted by the Master is the Slave Address followed by the FtW bit. The Slave acknowledges by sending a "1" bit.

First Byte Transmitted on I²C Bus



External I²C Interface Condition

KEY	
	From Master to Slave
	From Master to Slave, but can be omitted if followed by the correct sequence Normally data transfer is terminated by a STOP condition generated by the Master. However, if the Master still wishes to communicate on the bus, it can generate a repeated START condition, and address another Slave address without first generating a STOP condition.
	From Slave to Master

SYMBOLS:

ACK - Acknowledge (SDA LOW)
NACK - Not Acknowledge (SDA HIGH)
Sr - Repeated Start Condition
S - START Condition
P - STOP Condition

EEPROM Interface

The 5P49EE802 can store its configuration in an internal EEPROM. The contents of the device's internal programming registers can be saved to the EEPROM by issuing a save instruction (ProgSave) and can be loaded back to the internal programming registers by issuing a restore instruction (ProgRestore).

To initiate a save or restore using I²C, only two bytes are transferred. The Device Address is issued with the read/write bit set to "0", followed by the appropriate command code. The save or restore instruction executes after the STOP condition

is issued by the Master, during which time the 5P49EE802 will not generate Acknowledge bits. The 5P49EE802 will acknowledge the instructions after it has completed execution of them. During that time, the I²C bus should be interpreted as busy by all other users of the bus.

On power-up of the 5P49EE802, an automatic restore is performed to load the EEPROM contents into the internal programming registers. The 5P49EE802 will be ready to accept a programming instruction once it acknowledges its 7-bit I²C address.

Progwrite

S	Address	R/W	ACK	Command Code	ACK	Register	ACK	Data	ACK	Р
	7-bits	0	1-bit	8-bits: xxxxxx00	1-bit	8-bits	1-bit	8-bits	1-bit	

Progwrite Command Frame

Writes can continue as long as a Stop condition is not sent and each byte will increment the register address.



Progread

Note: If the expected read command is not from the next higher register to the previous read or write command, then set a known "read" register address prior to a read operation by issuing the following command:

s	Address	R/W	ACK	Command Code	ACK	Register	ACK	/#//
	7-bits	0	1-bit	8-bits: xxxxxx00	1-bit	8-bits	1-bit	

Prior to Progread Command Set Register Address

The user can ignore the STOP condition above and use a repeated START condition instead, straight after the slave acknowledgement bit (i.e., followed by the Progread command):

•	3	Address	R/W	ACK	ID Byte	ACK	Data_1	ACK	Data_2	ACK	Data_last	NACK	Р
		7-bits	1	1-bit	8-bits	1-bit	8-bits	1-bit	8-bits	1-bit	8-bits	1-bit	

Progread Command Frame

Progsave

[;	s	Address	R/W	ACK	Command Code	ACK	Р
		7-bits	0	1-bit	8-bits:xxxxxx01	1-bit	

Note:

PROGWRITE is for writing to the 5P49EE802 registers.

PROGREAD is for reading the 5P49EE802 registers.

PROGSAVE is for saving all the contents of the 5P49EE802 registers to the EEPROM.

PROGRESTORE is for loading the entire EEPROM contents to the 5P49EE802 registers.

Progrestore

s	Address	R/W	ACK	Command Code	ACK	Р
	7-bits	0	1-bit	8-bits:xxxxxxx10	1-bit	

During PROGRESTORE, outputs will be turned off to ensure that no improper voltage levels are experienced before initialization.



I²C Bus DC Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{IH}	Input HIGH Level		0.7xVDDO1		5.5	V
V _{IL}	Input LOW Level				0.3xVDDO1	V
V _{HYS}	Hysteresis of Inputs		0.05xVDDO1			V
I _{IN}	Input Leakage Current	$V_{DD} = 0V$			±1.0	μΑ
V _{OL}	Output LOW Voltage	I _{OL} = 3 mA			0.4	V

I²C Bus AC Characteristics for Standard Mode

Symbol	Parameter	Min	Тур	Max	Unit
F _{SCLK}	Serial Clock Frequency (SCL)	0		100	kHz
t _{BUF}	Bus free time between STOP and START	4.7			μs
t _{SU:START}	Setup Time, START	4.7			μѕ
t _{HD:START}	Hold Time, START	4			μs
t _{SU:DATA}	Setup Time, data input (SDA)	250			ns
t _{HD:DATA}	Hold Time, data input (SDA) ¹	0			μs
t _{OVD}	Output data valid from clock			3.45	μs
C _B	Capacitive Load for Each Bus Line			400	pF
t _R	Rise Time, data and clock (SDA, SCLK)			1000	ns
t _F	Fall Time, data and clock (SDA, SCLK)			300	ns
t _{HIGH}	HIGH Time, clock (SCLK)	4			μs
t _{LOW}	LOW Time, clock (SCLK)	4.7			μs
t _{SU:STOP}	Setup Time, STOP	4			μs

¹⁾ No activity is allowed on I2C lines until VDD>1.62V.

²⁾ A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the $V_{IH}MIN$ of the SCLK signal) to bridge the undefined region of the falling edge of SCLK.



I²C Bus AC Characteristics for Fast Mode

Symbol	Parameter	Min	Тур	Max	Unit
F _{SCLK}	Serial Clock Frequency (SCL)	0		400	kHz
t _{BUF}	Bus free time between STOP and START	1.3			μs
t _{SU:START}	Setup Time, START	0.6			μs
t _{HD:START}	Hold Time, START	0.6			μs
t _{SU:DATA}	Setup Time, data input (SDA)	100			ns
t _{HD:DATA}	Hold Time, data input (SDA) ¹	0			μs
t _{OVD}	Output data valid from clock			0.9	μs
C _B	Capacitive Load for Each Bus Line			400	pF
t _R	Rise Time, data and clock (SDA, SCL)	20 + 0.1xC _B		300	ns
t _F	Fall Time, data and clock (SDA, SCL)	20 + 0.1xC _B		300	ns
t _{HIGH}	HIGH Time, clock (SCL)	0.6			μs
t _{LOW}	LOW Time, clock (SCL)	1.3			μs
t _{SU:STOP}	Setup Time, STOP	0.6			μs

¹⁾ No activity is allowed on I2C lines until VDD>1.62V.

²⁾ A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the $V_{IH}MIN$ of the SCL signal) to bridge the undefined region of the falling edge of SCL.



Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the 5P49EE802. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Symbol	Description	Max	Unit
V_{DD}	Internal Power Supply Voltage	-0.5 to +4.6	V
V _I	Input Voltage	-0.5 to +4.6	V
V _O	Output Voltage (not to exceed 4.6 V)	-0.5 to V _{DD} +0.5	V
T _J	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-65 to +150	°C

Recommended Operation Conditions

Symbol	Parameter	Min	Тур	Max	Unit
V_{DD} , $V_{DD}x$	Power supply voltage for core VDD	1.71	1.8	1.89	V
V _{DDOX}	Power supply voltage for outputs VDDO1/2/3	1.71	1.8	1.89	V
		2.375	2.5	2.625	V
		3.135	3.3	3.465	V
T _A	Operating temperature, ambient	-40		+85	°C
C _{LOAD_OUT}	Maximum load capacitance (3.3V LVTTL only)			15	pF
C _{LOAD_OUT}	Maximum load capacitance (1.8V or 2.5V LVTTL only)			8	pF
F _{IN}	External reference crystal	8		30	MHz
	External reference clock CLKIN	1		40	
t _{PU}	Power up time for all V _{DD} s to reach minimum specified voltage (power ramps must be monotonic)	0.05		5	ms

Capacitance ($T_A = +25$ °C, f = 1 MHz, $V_{IN} = 0V$)

Symbol	Parameter	Min	Тур	Max	Unit			
C _{IN}	Input Capacitance		3		pF			
Crystal Specificat	Crystal Specifications							
XTAL_FREQ	Crystal frequency	8		30	MHz			
XTAL_MIN	Minimum crystal load capacitance		7		pF			
XTAL_MAX	Maximum crystal load capacitance		20		pF			

DC Electrical Characteristics for 3.3V LVTTL ¹

Symbol	Parameter	Parameter Test Conditions		Тур	Max	Unit
V _{OH}	Output HIGH Voltage	I _{OH} = 33mA	2.4		VDDO	V
V_{OL}	Output LOW Voltage	I _{OH} = 33mA			0.4	V
I _{OZDD}	Output Leakage Current	3-state outputs			5	μΑ



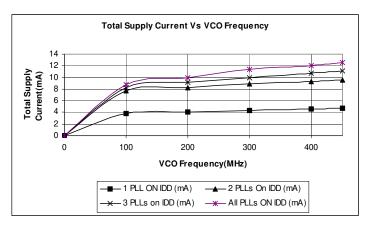
DC Electrical Characteristics for 2.5V LVTTL ¹

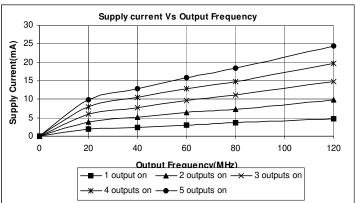
Symbol	Parameter	Parameter Test Conditions		Тур	Max	Unit
V _{OH}	Output HIGH Voltage	I _{OH} = 25mA	2.1		VDDO	V
V_{OL}	Output LOW Voltage	I _{OH} = 25mA			0.4	٧
I _{OZDD}	Output Leakage Current	3-state outputs			5	μΑ

DC Electrical Characteristics for 1.8V LVTTL ¹

Symbol	Parameter Test Conditions Min		Min	Тур	Max	Unit
V _{OH}	Output HIGH Voltage	VDDO = 1.71V to 1.89V	1.23		VDDO	V
V _{OL}	Output LOW Voltage				0.6	V
V_{IH}	Input HIGH Voltage	SEL[1:0], 3.3V tolerant	1.35			٧
V _{IL}	Input LOW Voltage	SEL[1:0], 3.3V tolerant			0.45	٧
I _{OZDD}	Output Leakage Current	3-state outputs			5	μΑ

Power Supply Characteristics for LVTTL Outputs





Note 1: See "Recommended Operating Conditions" table. Alway completely power up VDD and VDDx prior to applying VDDO power.



AC Timing Electrical Characteristics for 3.3V

(Spread Spectrum Generation = OFF)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
f _{IN}	Input Frequency	Input Frequency Limit (CLKIN)	1 ¹		40	MHz
1 / t1	Output Frequency	Single Ended Clock output limit (LVTTL) 3.3V	0.001		120	MHz
f _{VCO}	VCO Frequency	VCO operating Frequency Range	100		475	MHz
t2	Input Duty Cycle	Duty Cycle for Input	40		60	%
t3	Output Duty Cycle	Measured at VDD/2	45		55	%
t4	Slew Rate, SLEWx(bits) = 00	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		5.1		V/ns
	Slew Rate, SLEWx(bits) = 01	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		3.8		
	Slew Rate, SLEWx(bits) = 10 Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)			2.6		
	Slew Rate, SLEWx(bits) = 11	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD Output Load = 7 pF)		1.8		
t5	Clock Jitter ³	Peak-to-peak period jitter, CLK outputs measured at VDD/2; f _{PFD} >= 10 MHz Single output frequency only.			150	ps
		Peak-to-peak period jitter, CLK outputs measured at VDD/2; f _{PFD} >= 10 MHz Multiple output frequencies switching.			200	ps
t6	Output Skew	Skew between output to output on the same bank			75	ps
		Skew between any output (Same freq and IO type, FOUT >10MHz)			200	ps
t7	Lock Time	PLL Lock Time from Power-up (using MHz reference clock) ¹		5	20	ms
		PLL Lock Time from Power-up using 32.768kHz reference clock)		1	3	S
		PLL Lock time from shutdown mode		5	10	ms

^{1.}Input clock (square wave) may be used at 1 MHz.

^{2.} Time from supply voltage crosses VDD=1.62V to PLLs are locked.

^{3.} Not guaranteed until customer specific configuration is approved by IDT.



AC Timing Electrical Characteristics for 2.5V

(Spread Spectrum Generation = OFF)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
f _{IN}	Input Frequency	Input Frequency Limit (CLKIN)	1 ¹		40	MHz
1 / t1	Output Frequency	Single Ended Clock output limit (LVTTL) 2.5V	0.001		110	MHz
f _{VCO}	VCO Frequency	VCO operating Frequency Range	100		475	MHz
t2	Input Duty Cycle	Duty Cycle for Input	40		60	%
t3	Output Duty Cycle	Measured at VDD/2	45		55	%
t4	Slew Rate, SLEWx(bits) = 00	Single-Ended 2.5V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		3.6		V/ns
	Slew Rate, SLEWx(bits) = 01	Single-Ended 2.5V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		2.0		
	Slew Rate, SLEWx(bits) = 10 Single-Ended 2.5V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)			1.4		
	Slew Rate, SLEWx(bits) = 11	Single-Ended 2.5V LVCMOS Output clock rise and fall time, 20% to 80% of VDD Output Load = 7 pF)		1.0		
t5	Clock Jitter ³	Peak-to-peak period jitter, CLK outputs measured at VDD/2; f _{PFD} >= 10 MHz Single output frequency only.			150	ps
		Peak-to-peak period jitter, CLK outputs measured at VDD/2; f _{PFD} >= 10 MHz Multiple output frequencies switching.			200	ps
t6	Output Skew	Skew between output to output on the same bank			75	ps
		Skew between any output (Same freq and IO type, FOUT >10MHz)			200	ps
t7	Lock Time	PLL Lock Time from Power-up (using MHz reference clock) ¹		5	20	ms
		PLL Lock Time from Power-up using 32.768kHz reference clock)		1	3	S
		PLL Lock time from shutdown mode		5	10	ms

^{1.}Input clock (square wave) may be used at 1 MHz.

^{2.} Time from supply voltage crosses VDD=1.62V to PLLs are locked.

^{3.} Not guaranteed until customer specific configuration is approved by IDT.



AC Timing Electrical Characteristics for 1.8V

(Spread Spectrum Generation = OFF)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
f _{IN}	Input Frequency	Input Frequency Limit (CLKIN)	1 ¹		40	MHz
1 / t1	Output Frequency	Single Ended Clock output limit (LVTTL) 1.8V	0.001		100	MHz
f _{VCO}	VCO Frequency	VCO operating Frequency Range	100		475	MHz
t2	Input Duty Cycle	40		60	%	
t3	Output Duty Cycle Measured at VDD/2				55	%
t4	Slew Rate, SLEWx(bits) = 00	Single-Ended 1.8V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		1.3		V/ns
	Slew Rate, SLEWx(bits) = 01	Single-Ended 1.8V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		0.8		
	Slew Rate, SLEWx(bits) = 10	Single-Ended 1.8V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		0.6		
	Slew Rate, SLEWx(bits) = 11	Single-Ended 1.8V LVCMOS Output clock rise and fall time, 20% to 80% of VDD Output Load = 7 pF)		0.4		
t5	Clock Jitter ³	Peak-to-peak period jitter, CLK outputs measured at VDD/2; f _{PFD} >= 10 MHz Single output frequency only.			300	ps
		Peak-to-peak period jitter, CLK outputs measured at VDD/2; f _{PFD} >= 10 MHz Multiple output frequencies switching.			400	ps
t6	Output Skew	Skew between output to output on the same bank			75	ps
		Skew between any output (Same freq and IO type, FOUT >10MHz)			200	ps
t7	Lock Time	PLL Lock Time from Power-up (using MHz reference clock) ¹		5	20	ms
		PLL Lock Time from Power-up using 32.768kHz reference clock)		1	3	S
		PLL Lock time from shutdown mode		5	10	ms

^{1.}Input clock (square wave) may be used at 1 MHz.

^{2.} Time from supply voltage crosses VDD=1.62V to PLLs are locked.

^{3.} Not guaranteed until customer specific configuration is approved by IDT.

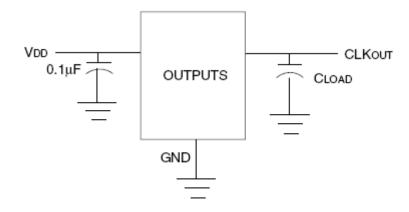


Spread Spectrum Generation Specifications

Symbol	Parameter	Description Min Typ Max					
f _{IN}	Input Frequency	Input Frequency Limit	1 1 40			MHz	
f _{MOD}	Mod Frequency	Modulation Frequency ³	32 120			kHz	
f _{SPREAD}	Spread Value	Amount of Spread Value (programmable) - Down Spread	Pro	gramm	able	%f _{OUT}	
		Amount of Spread Value (programmable) - Center Spread	Programmable				
	Total Spread Value				4.0		

- ${\bf 1.}\ {\bf Practical}\ lower\ frequency\ is\ determined\ by\ loop\ filter\ settings.$
- 2. Modulation spread percentage is tested on every part and trimming for guaranteed accuracy.
- 3. Not guaranteed until customer specific configuration is approved by IDT.

Test Circuits and Conditions ¹

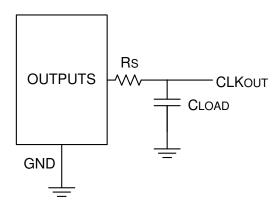


NOTE:

1. All Vco pins must be tied together.

Test Circuits for DC Outputs

Other Termination Scheme (Block Diagram)



Total load capacitance = 7pF



Programming Registers Table

Addr	Default				E	Bit #				Description		
	Register Hex Value	-	6	5	4	3	2	1	0			
0x00	0	ONXTALB		2[1:0]		(1[1:0]	XTAL32ONB		served	ONXTALB - MHz Crystal active low CSX2 [1:0]- internal 32kHz crystal cap2 00 - 18pF; 10 - 30pF 01 - 24pF; 11 - 36pF CSX1 [1:0] - Internal 32kHz crystal cap1 00 - 0pF; 10 - 6pF 01 - 3pF; 11 - 9pF XTAL32ONB - 32k crystal active low		
0x01	4	INV[0]	SLEW	/0[1:0]	No_PD		80[2:1]	Re	served	No_PD - Enables/Disables 32kHz clock output on Config 00.		
0x02	0	1810/041	OL EV	(4.14.01		served	240.41	Б.	d	No_PD=0 - 32kHz is off.		
0x03 0x04	0	INV[1] INV[2]	SLEW SLEW		Reserved Reserved		S12:1] S2[2:1]		served served	No_PD=1 - 32kHz remains active.		
0x04	0	IINV[Z]	SLEW	72[1.0]		eserved	02[2.1]	ne	serveu	INV[#] - Invert output#		
0x06	10	INV[3]	SLEW	/3[1:0]	Reserved		3[2:1]	Re	served	SLEW#[0:1] - output# slew setting 0 0 - 5.1V/ns		
0x07	4	INV[4]		/4[1:0]	Reserved		642:1]		served	0 1 - 4.4V/ns		
0x08	4	INV[5]		/5[1:0]	Reserved		55[2:1]	Re	served	1 0 - 2.8V/ns		
0x09	0	INV[6B]	INV[6A]	SLE	SLEW6[0:1]		Rese	rved		rved		-1 1 - 1.8V/ns PS#[2:1] -Power Select 00 - Reserved 01 - CLK# connects to VDDO1 10 - CLK# connects to VDDO2 11 - CLK# connects to VDDO3
0x0A	0				Re	served						
0x0B	0				Re	served						
0x0C	0					served						
0x0D	0					eserved						
0x0E	0					FA[7:0]				Configuration0 REFA[7:0] - Reference Divide PLLA		
0x0F	4			Recented		A[10:3)		EBV(3:0)		FBA[10:0] - Feedback Divide PLLA		
0x10 0x11	0 1A	Reserved	XDIVA	Reserved	d ZA[1:0]		IPA[2:0]	FBA[2:0)	REFSELA	XDIVA - FB predivide PLLA;		
0,40					0.5	EDI7.01				0 - /1; 1 - /4 RZA[1:0] - Zero Resistor PLLA 00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm 11 - 80kOhm IPA[2:0] - charge Pump Current PLLA 100 - 6.3uA 101 - 11.9 uA 110 - 17.7 uA 111 - 22.7uA REFSELA - Clock input PLLA 0 - MHz input 1 - 32kHz input		
0x12	0					FB[7:0]				REFB[7:0] - Reference Divide PLLB		
0x13	1				FB	B[10:3]				FBB[10:0] - Feedback Divide PLLB		



Addr	Default					Bit #				Description
	Register Hex Value	7	6	5	4	3	2	1	0	
0x14	8		1	MOD[4:0]	ı			FBB[2:0]	I.	PLLB Spread Parameters MOD[12:0]
0x15	11								NC[10:0]	
0x16	7D				N	IC[10:3]				NSS[12:0]
0x17	90			NSS[4:0]		00110 =1		NC[2:0]		_
0x18	1F 55		Danamad		N:	SS[12:5] IPB[2:0]			D(4.01	DZD[1:0] Zove Decister DLLD
0x19 0x1A	1		Reserved	Rose	erved	IPB[2:0]		REFSELB	B[1:0] SSENB_B	RZB[1:0] - Zero Resistor PLLB 00 - 5kOhm
OXIA	·			Hook				TIEI GEES	GOLIND_B	01 - 10kOhm 10 - 30kOhm 11 - 80kOhm IPB[2:0] - charge Pump Current PLLB 000 - 0.37uA, 100 - 6.3uA 001 - 1.1uA, 101 - 11.9uA 010 - 1.8 uA, 110 - 17.7uA 011 - 3.4uA, 111 - 22.7uA REFSELB - Clock input PLLB
										0 - MHz input 1 - 32kHz input
0x1B	0					EFC[7:0]				REFC[7:0] - Reference Divide PLLC
0x1C 0x1D	30			Danamirad	FE	3C[10:3]		ED0[0.0]		FBC[10:0] - Feedback Divide PLLC
0x1D	0 A			Reserved		3C2[7:0]		FBC[2:0]		FBC2 - Feedback Predivide PLLC
UXIL	^					ال ۱۱ع۵د			Turn on using XDIVC=1	
0x1F	BO		IPC[2:0]			C[1:0]	Reserved	XDIVC	REFSELC	RZC[1:0] - Zero Resistor PLLC 00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm IPC[2:0] - charge Pump Current PLLC 100 - 6.3uA 101 -11.9 uA 110 - 17.7 uA 111 - 22.7uA REFSELC 0 - MHz input 1 - 32kHz input
0x20	0					EFD[7:0]				REFD[7:0] - Reference Divide PLLD
0x21	3			Dosamiral	FE	3D[10:3]		EDDIO O		FBD[10:0] - Feedback Divide PLLD
0x22 0x23	30	XDIVD	RZC	Reserved D[1:0]		IPD[2:0]		FBD[2:0]	ELD[1:0]	XDIVD - FB predivide PLLD; 0 - /1; 1 - /4 RZD[1:0] - Zero Resistor PLLD 00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm IPD[2:0] - charge Pump Current PLLD 100 - 6.3uA 101 -11.9 uA 110 - 17.7 uA 111 - 22.7uA REFSELD[1:0] 00 - MHz input 11 - 32kHz input Others - Reserved



Addr	Default				E	Bit #				Description
	Register Hex Value	7	6	5	4	3	2	1	0	
0x24	5				00	00[7:0]				OD#[7:0] - Output Divide#
0x25	С				Re	served				
0x26	F				00	01[7:0]				
0x27	1				00	02[7:0]				
0x28	12				Re	served				
0x29	8				00	03[7:0]				
0x2A	1				00	04[7:0]				
0x2B	4				00	05[7:0]				
0x2C	4				O	06[7:0]				
0x2D 0x2E	10		erved		5[1:0] 2[1:0]		:4[1:0] :1[1:0]	SCR3[1:0]		SRC6[1:0] - OD6 source 00 - off; 10 - PLLC 01 - PLLA; 11 - MHz Reference SRC5[1:0] - OD5 source 00 - off; 10 - PLLA 01 - PLLC; 11 - PLLB SRC4[1:0] - OD4 source 00 - off; 10 - MHz Reference 01 - PLLC; 11 - 32kHz Reference SRC3[1:0] - OD3 source 00 - off; 10 - 32kHz Reference 01 - MHz Reference; 11 - PLLD SRC2[1:0] - OD2 source 00 - off; 10 - PLLB 01 - 32kHz Reference; 11 - PLLD SRC1[1:0] - OD1 source 00 - off; 10 - PLLB 01 - 32kHz Reference; 11 - PLLD SRC1[1:0] - OD1 source 00 - off; 10 - PLLC
0.05	4	0.05	2014 01							01 - PLLA; 11 - PLLD
0x2F	1	SCF	CR0[1:0] Reserved							SRC0[1:0] - OD0 source 00 - off: 10 - PLLC
0x30	FF			Reserved						01 - PLLB; 11 - PLLD
0x31	В0	PDB[6]	Reserved	OE[6B]	OE[6A]		Res	served		PDB[#] - Powerdown OUT#.
0x32	FF	OE[5]	OE[4]	OE[3]	Reserved	OE[2]	OE[1]	Reserved	OE[0]	PDB[#]=0, OUT# driven low
0x33	FF	PDB[5]	PDB[4]	PDB[3]	Reserved	PDB[2]	PDB[1]	Reserved	PDB[0]	OE[#] - Output enable OUT#. OE[#]=0, OUT# tri-stated. If PDB#=OE#=0, OUT# driven low



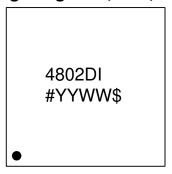
Register Hax Value	Addr	Default		Bit #							Description
Discription Test		Hex Value	7	6	5			2	1	0	
Display		0									
0.00						FB.	A[10:3)				
DA38									FBA[2:0)		above)
Display			Reserved	XDIVA	RZA			IPA[2:0]		REFSELA	
0x3A 8 MOD[4:0] FBB[2:0] 0x3B 11 MOD[12:5] NC[10:3] 0x3D 90 NSS[4:0] NC[2:0] NC[2:0] 0x3E 1F NSS[12:5] NC[2:0] RZB[1:0] 0x4D 1 Reserved IPB[2:0] RZB[1:0] 0x41 0 REFC[7:0] REFSELB SSENB_B 0x41 0 REFC[7:0] REFSELB SSENB_B 0x41 0 REFC[7:0] REFSELB SSENB_B 0x41 0 REFC[7:0] REFSELD REFSELD 0x42 30 REFSELD[1:0] REFSELD REFSELD 0x44 A FBC2[7:0] REFSELD REFSELO 0x46 0 REFD[7:0] REFSELD REFSELO 0x49 B0 XDIVD RZD[1:0] PBD[0:0] REFSELD[1:0] 0x4B C Reserved PBD[0:0] REFSELD[1:0] REFSELD[1:0] 0x4B C Reserved PBD[0:0]											
0x3B 11 MOD[12:5] 0x3C 7D NC[10:3] 0x3D 90 NSS[4:0] NC[2:0] 0x3E 1F NSS[12:5] RZB[1:0] 0x4D 1 Reserved IPB[2:0] RZEFLID 0x41 0 REFSELB SSENB_B 0x41 0 REFC[7:0] REFSELB SSENB_B 0x42 30 FBC[10:3] FBC[2:0] 0x44 A FBC2[7:0] REFSELB SSENB_B 0x44 A FBC2[7:0] REFSELD REFSELD 0x44 A FBC2[7:0] REFSELD REFSELD 0x45 B0 IPC[2:0] RZC[1:0] REFSELD REFSELD 0x46 0 REFPD[7:0] REFSELD REFSELD REFSELD 0x47 0 FBD[10:3] FBD[2:0] REFSELD REFSELD REFSELD REFSELD REFSELD REFSELD REFSELD REFSELD RESERVED DCD(7:0) DCD(7:0) REFSELD						FB	B[10:3]				
0x3C 7D NC[10:3] NC[2:0] 0x3B 1F NSS[4:0] NSS[12:5] 0x4F 55 Reserved IPB[2:0] REFSELB 0x40 1 Reserved REFC[7:0] 0x42 30 FBC[10:3] 0x43 0 Reserved FBC[2:0] 0x44 A FBC2[7:0] 0x45 B0 IPC[2:0] R2C[1:0] 0x46 0 REFD[7:0] 0x47 0 FBD[10:3] 0x48 6 Reserved FBD[2:0] 0x49 B0 XDIVD RZD[1:0] IPD[2:0] 0x49 B0 XDIVD RZD[1:0] REFSELD[1:0] 0x40 5 OD0[7:0] REFSELD[1:0] 0x40 F OD1[7:0] OD2[7:0] 0x40 F OD2[7:0] OD2[7:0] 0x40 F OD2[7:0] OD2[7:0] 0x40 F OD2[7:0] OD3[7:0] 0x4E <					MOD[4:0]				FBB[2:0]		
0x3D 90 NSS[4:0] NSC[12:5] 0x3E 1F NSS[12:5] RZB[1:0] 0x40 1 Reserved IPB[2:0] REFSELB SSENB_B 0x41 0 REFC[7:0] REFC[7:0] REFSELB SSENB_B 0x42 30 REFC[7:0] REFC[7:0] REFC[7:0] REFC[7:0] 0x43 0 RESERVED FBC[2:0] REFC[7:0] REFC[7:0] 0x44 A FBC[7:0] REFC[7:0] REFC[7:0] <td></td>											
0x3E 1F NSS[12:5] RZB[1:0] 0x40 1 Reserved IPB[2:0] RZB[1:0] 0x41 0 REFC[7:0] REFSELB SSENB_B 0x41 0 REFC[7:0] REFC[7:0] REFC[7:0] 0x42 30 Reserved FBC[2:0] FBC[2:0] 0x44 A FBC[7:0] REFC[7:0] REFC[7:0] 0x44 A FBC[7:0] REFSELC REFD[1:0] REFSELC 0x46 0 REFD[1:0] REFSELD[1:0] REFSELD[1:0] REFSELD[1:0] 0x46 6 Reserved FBD[10:3] FBD[10:3] REFSELD[1:0] RESERVED[1:0] RESERVED[1:0] RESERVED[1:0] RESERVED[1:0] <t< td=""><td></td><td></td><td></td><td></td><td></td><td>NC</td><td>C[10:3]</td><td></td><td></td><td></td><td></td></t<>						NC	C[10:3]				
DX3F 55					NSS[4:0]				NC[2:0]		
0x40 1 Reserved REFSELB SSENB_B 0x41 0 REFC[7:0] REFC[7:0]<						NS					
0x41 0 REFC[7:0] 0x42 30 Reserved FBC[10:3] 0x44 A FBC2[7:0] Reserved 0x45 B0 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 0 REFD[7:0] REFD[10:3] REFSELD[1:0] REFSELD[1:0] 0x47 0 FBD[10:3] REFSELD[1:0] REFSELD[1:0] 0x49 B0 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x44 5 OD0[7:0] REFSELD[1:0] REFSELD[1:0] 0x4B C Reserved OD1[7:0] OD2[7:0] 0x4C F OD1[7:0] OD2[7:0] OD3[7:0] OD3[7:0] 0x4F 8 OD3[7:0] OD4[7:0] OD5[7:0]		55		Reserved			IPB[2:0]				
0x42 30 FBC[10:3] 0x43 0 Reserved FBC[2:0] 0x44 A FBC2[7:0] Reserved XDIV REFSELC 0x45 B0 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 0 REFD[10:3] FBD[2:0] REFSELD[1:0] REFSELD[1:0] 0x49 B0 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] REFSELD[1:0] 0x4A 5 OD0[7:0]		1			Res				REFSELB	SSENB_B	
0x43 0 Reserved FBC[2:0] 0x44 A FBC2[7:0] REFSELC 0x45 B0 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 0 REFD[7:0] FBD[0:3] FBD[2:0] REFSELD[1:0] 0x47 0x48 6 Reserved FBD[2:0] REFSELD[1:0] 0x48 0x49 B0 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] REFSELD[1:0] 0x48 0x48 0 0x49 REFSELD[1:0] 0x51 0x51 Name 0x52 0x52 0x52 0x54		-									
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0x45 B0 IPC[2:0] RZC[1:0] Reserved XDIV REFSELC 0x46 0 REFD[7:0] FBD[10:3] 0x47 0 FBD[10:3] FBD[2:0] FBD[2:0] 0x48 6 Reserved FBD[2:0] REFSELD[1:0] 0x4A 5 OD0[7:0] 0x4B C Reserved 0x4C F OD1[7:0] 0x4E 16 Reserved 0x4F 8 OD3[7:0] 0x50 1 OD4[7:0] 0x51 4 OD5[7:0] 0x52 1 OD6[7:0] 0x53 DC SCR6[1:0] SCR5[1:0] SCR3[1:0] SCR3[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved 0x56 FF OE[6] OE[6] OE[6] OE[6] <t< td=""><td>0x43</td><td>0</td><td></td><td></td><td>Reserved</td><td></td><td></td><td></td><td>FBC[2:0]</td><td></td><td></td></t<>	0x43	0			Reserved				FBC[2:0]		
0x46 0 REFD[7:0] 0x47 0 FBD[10:3] 0x48 6 Reserved FBD[2:0] 0x49 B0 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x4A 5 OD0[7:0] OD1[7:0] OD2[7:0] OD2[7:0] 0x4D 5 OD2[7:0] OD3[7:0] OD3[7:0] OD3[7:0] OD3[7:0] OD3[7:0] OD3[7:0] OD4[7:0] OD4[7:0] OD4[7:0] OD5[7:0]	0x44	Α				FB	C2[7:0]	1			1
0x47 0 FBD[10:3] 0x48 6 Reserved FBD[2:0] 0x49 B0 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x4A 5 OD0[7:0] OD1[7:0] OD1[7:0] OD1[7:0] OD1[7:0] OD1[7:0] OD2[7:0] OD2[7:0] OD3[7:0]	0x45	В0		IPC[2:0]				Reserved	XDIV	REFSELC	
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0x49 B0 XDIVD RZD[1:0] IPD[2:0] REFSELD[1:0] 0x4A 5 OD0[7:0]	0x47	0				FB	D[10:3]				1
0x4A 5 OD0[7:0] 0x4B C Reserved 0x4C F OD1[7:0] 0x4D 5 OD2[7:0] 0x4E 16 Reserved 0x4F 8 OD3[7:0] 0x50 1 OD4[7:0] 0x51 4 OD5[7:0] 0x52 1 OD6[7:0] 0x53 DC SCR6[1:0] SCR5[1:0] SCR4[1:0] SCR3[1:0] 0x54 20 Reserved SCR2[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved 0x56 FF Reserved OE[6B] OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x48	6			Reserved				FBD[2:0]		1
0x4B C Reserved 0x4C F OD1[7:0] 0x4D 5 OD2[7:0] 0x4E 16 Reserved 0x4F 8 OD3[7:0] 0x50 1 OD4[7:0] 0x51 4 OD5[7:0] 0x52 1 OD6[7:0] 0x53 DC SCR6[1:0] SCR5[1:0] SCR4[1:0] SCR3[1:0] 0x54 20 Reserved SCR2[1:0] SCR1[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved Reserved 0x56 FF Reserved OE[6B] OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x49	В0	XDIVD	RZD	[1:0]		IPD[2:0]	11	REFS	ELD[1:0]	7
0x4C F OD1[7:0] 0x4D 5 OD2[7:0] 0x4E 16 Reserved 0x4F 8 OD3[7:0] 0x50 1 OD4[7:0] 0x51 4 OD5[7:0] 0x52 1 OD6[7:0] 0x53 DC SCR6[1:0] SCR4[1:0] SCR3[1:0] 0x54 20 Reserved SCR2[1:0] SCR1[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved Reserved 0x56 FF Reserved OE[6B] OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x4A	5				00	00[7:0]		1		7
0x4D 5 OD2[7:0] 0x4E 16 Reserved 0x4F 8 OD3[7:0] 0x50 1 OD4[7:0] 0x51 4 OD5[7:0] 0x52 1 OD6[7:0] 0x53 DC SCR6[1:0] SCR5[1:0] SCR4[1:0] SCR3[1:0] 0x54 20 Reserved SCR2[1:0] SCR1[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved Reserved 0x56 FF Reserved OE[6B] OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x4B	С				Re	served				7
0x4E 16 Reserved 0x4F 8 OD3[7:0] 0x50 1 OD4[7:0] 0x51 4 OD5[7:0] 0x52 1 OD6[7:0] 0x53 DC SCR6[1:0] SCR5[1:0] SCR4[1:0] SCR3[1:0] 0x54 20 Reserved SCR2[1:0] SCR1[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved 0x56 FF Reserved Reserved 0x57 B0 PDB[6] Reserved OE[6B] OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x4C	F				O	D1[7:0]				7
0x4F 8 OD3[7:0] 0x50 1 OD4[7:0] 0x51 4 OD5[7:0] 0x52 1 OD6[7:0] 0x53 DC SCR6[1:0] SCR5[1:0] SCR4[1:0] SCR3[1:0] 0x54 20 Reserved SCR2[1:0] SCR1[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved 0x56 FF Reserved OE[6A] Reserved 0x57 B0 PDB[6] Reserved OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x4D	5				O	02[7:0]				7
0x50 1 OD4[7:0] 0x51 4 OD5[7:0] 0x52 1 OD6[7:0] 0x53 DC SCR6[1:0] SCR5[1:0] SCR4[1:0] SCR3[1:0] 0x54 20 Reserved SCR2[1:0] SCR1[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved 0x56 FF Reserved Reserved 0x57 B0 PDB[6] Reserved OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x4E	16				Re	served				7
0x51 4 OD5[7:0] 0x52 1 OD6[7:0] 0x53 DC SCR6[1:0] SCR5[1:0] SCR4[1:0] SCR3[1:0] 0x54 20 Reserved SCR2[1:0] SCR1[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved 0x56 FF Reserved Reserved 0x57 B0 PDB[6] Reserved OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x4F	8				O	03[7:0]				7
0x52 1 OD6[7:0] 0x53 DC SCR6[1:0] SCR5[1:0] SCR4[1:0] SCR3[1:0] 0x54 20 Reserved SCR2[1:0] SCR1[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved 0x56 FF Reserved Reserved 0x57 B0 PDB[6] Reserved OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x50	1				10	04[7:0]				
0x53 DC SCR6[1:0] SCR5[1:0] SCR4[1:0] SCR3[1:0] 0x54 20 Reserved SCR2[1:0] SCR1[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved 0x56 FF Reserved 0x57 B0 PDB[6] Reserved OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x51	4				10	05[7:0]				7
0x54 20 Reserved SCR2[1:0] SCR1[1:0] Reserved 0x55 C1 SCR0[1:0] Reserved 0x56 FF Reserved 0x57 B0 PDB[6] Reserved Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[0]	0x52	1								-	
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0x55 C1 SCR0[1:0] Reserved 0x56 FF Reserved 0x57 B0 PDB[6] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved		20									†
0x56 FF Reserved 0x57 B0 PDB[6] Reserved OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[2] OE[1] Reserved OE[0]			SCR0[1:0] Reserved								†
0x57 B0 PDB[6] Reserved OE[6B] OE[6A] Reserved 0x58 FF OE[5] OE[4] OE[3] Reserved OE[2] OE[1] Reserved OE[0]											†
0x58 FF OE[5] OE[4] OE[3] Reserved OE[2] OE[1] Reserved OE[0]			PDB[6]	Reserved	OE[6B]			Res	served		†
							OE[2]			OE[0]	†
									Reserved		-



Addr					В	Bit #				Description
	Register Hex Value	7	6	5	4	3	2	1	0	
0x5A	0					A[7:0]				Configuration2
0x5B	4				FB/	\[10:3)				(See definitions from Configuration0
0x5C	0			Reserved				FBA[2:0)		above)
0x5D	1A	Reserved	XDIVA	RZA			IPA[2:0]		REFSELA	
0x5E	0					-B[7:0]				
0x5F	1				FBE	3[10:3]				
0x60	8			MOD[4:0]				FBB[2:0]		
0x61	11					D[12:5]				
0x62	7D				NC	[10:3]				
0x63	90			NSS[4:0]				NC[2:0]		
0x64	1F				NSS	S[12:5]				
0x65	55		Reserved			IPB[2:0]			B[1:0]	
0x66	1			Res	erved			REFSELB	SSENB_B	
0x67	0					C[7:0]				
0x68	30				FBC	C[10:3]				
0x69	0			Reserved				FBC[2:0]		
0x6A	Α					C2[7:0]				
0x6B	В0		IPC[2:0]			[1:0]	Reserved	XDIV	REFSELC	
0x6C	0		REFD[7:0]							
0x6D	3				FBD	D[10:3]				
0x6E	0			Reserved				FBD[2:0]		
0x6F	30	XDIVD	RZD	[1:0]		IPD[2:0]	REFSELD[1:0]			
0x70	4					0[7:0]				
0x71	С					served				
0x72	F					1[7:0]				
0x73	1					2[7:0]				
0x74	16					served				
0x75	8					3[7:0]				
0x76	1					4[7:0]				
0x77	5	OD5[7:0]								
0x78	4	OD6[7:0]								
0x79	78		6[1:0]	SCR			4[1:0]		R3[1:0]	
0x7A	10	Reserved SCR2			2[1:0]	SCR1[1:0] Reserved				7
0x7B	81	SCR0[1:0] Reserved								7
0x7C	FF				7					
0x7D	В0	PDB[6]	Reserved	OE[6B]	OE[6A]			erved		7
0x7E	FF	OE[5]	OE[4]	OE[3]	Reserved	OE[2]	OE[1]	Reserved	OE[0]	
0x7F	FF	PDB[5]	PDB[4]	PDB[3]	Reserved	PDB[2]	PDB[1]	Reserved	PDB[0]	



Marking Diagram (NL28)



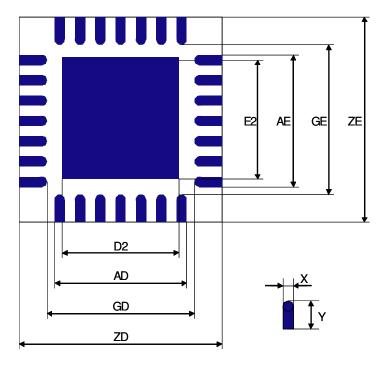
Notes:

- 1. "#" is the lot number.
- 2. YYWW is the last two digits of the year and week that the part was assembled.
- 3. "\$" is the assembly mark code.
- 4. "I" indicates industrial temperature range.

Thermal Characteristics 28-pin VFQFPN

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Thermal Resistance Junction to Ambient	θ_{JA}	Still air		48.6		°C/W
	θ_{JA}	1 m/s air flow		41.7		°C/W
	θ_{JA}	2.5 m/s air flow		37.7		°C/W
Thermal Resistance Junction to Case	$\theta_{\sf JC}$			55.1		°C/W

Landing Pattern



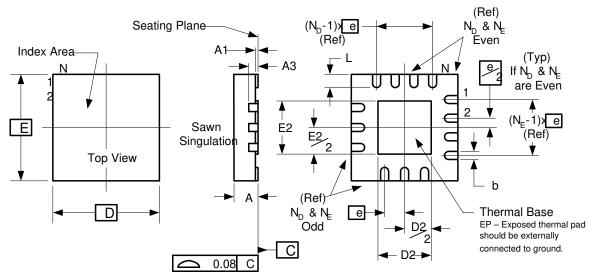
Dimensions					
X(max)	0.25				
Yref	0.76				
A(max)	2.65				
G(min)	2.9				
Z(max)	4.41				
E2/D2(max)	2.7				

Unit: mm



Package Outline and Package Dimensions (28-pin 4mm x 4mm QFN)

Package dimensions are kept current with JEDEC Publication No. 95



	Millimeters				
Symbol	Min	Max			
Α	0.80	1.00			
A1	0	0.05			
A3	0.20 Re	eference			
b	0.15	0.25			
е	0.40 BASIC				
N	28				
N _D	7				
N _E	7				
D x E BASIC	4.00 x 4.00				
D2	2.50	2.70			
E2	2.50	2.70			
L	0.30	0.50			

Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
5P49EE802NDGI	See page 26	Tray	28-pin VFQFPN	-40° to +85°C
5P49EE802NDGI8		Tape and Reel	28-pin VFQFPN	-40° to +85°C

[&]quot;G" after the two-letter package code are the Pb-Free configuration and are RoHS compliant.



Revision History

Rev.	Date	Originator	Description of Change				
	10/14/09	R.Willner	Initial Preliminary Datasheet				
Α	11/20/09	R.Willner	o_PD bit inclusion - 32kHz clock on/off in Config 00.				
В	3/25/10	R.Willner	Typographical changes. Correct spread spectrum calculations.				
С	6/02/10	R.Willner	Typographical changes. Default configuration.				
D	9/08/10	R.Willner	Updated thermal pad and dimensions on package drawing. Input Clock max voltage swing 1.8V. Power ramp sequence.				
Е	10/29/10	R. Willner	Typographical changes. Loop filter calculations. Default register bit corrections.				
F	01/19/11	R. Willner	Corrected notes for top-side marking.				
G	04/13/11	R. Willner	 Updated SCLK and SDA pin descriptions Updated DC Electrical Char table for 1.8V LVTTL; added VIH and VIL. Updated "Lock Time/PLL Lock Time from shutdown mode" Typ. and Max. specs in AC Timing Electrical Char table. 				
Н	05/04/11	R. Willner	Added Landing Pattern diagram.				
J	08/24/11	R. Willner	Corrected SRC1 connections in block diagram.				
K	0930/11	R. Willner	Updated Power-up/Power-down Sequence notes.				
L	10/17/11	R. Willner	Added VDDOx specs to Recomended Operations table Updated Power-up/down Sequence diagrams				
М	07/25/12	R. Willner	Added pin 1 indicator dot on marking diagram. Corrected typo in Register Map table; SLEWx[0:1] was changed to SLEWx[1:0]				
N	09/10/15	A. Borodulin	 Corrected minor textual typos throughout. Update VOH/VOL and VIH/VIL values in 1.8V LVTTL DC table. Update t4 and t5 specs in AC Electrical Characteristics table; added specific 3.3V to title. Created separate 2.5V and 1.8V Ac Electrical Characteristics tables. Added footnotes to Spread Spectrum Generation table. 				
Р	04/01/16	Z. Bhinder	Updated Default register Hex values throughout entire Programming Registers table. Updated note 2 under Pin Descriptions.				



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